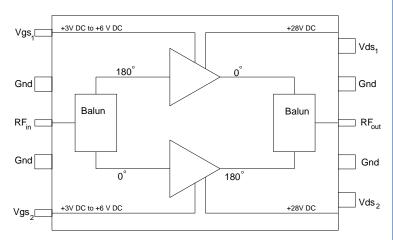


Product Description

Sirenza Microdevices' **SDM-08120** 130W power module is a robust impedance matched, single-stage, push-pull Class AB amplifier module suitable for use as a power amplifier driver or output stage. The power transistors are fabricated using Sirenza's latest, high performance LDMOS process. It is a drop-in, no-tune solution for high power applications requiring high efficiency, excellent linearity, and unit-to-unit repeatability. It is internally matched to 50 ohms.

Functional Block Diagram

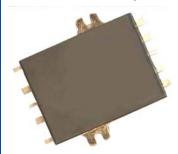


Case Flange = Ground

SDM-08120 SDM-08120Y



869-894 MHz Class AB 130W Power Amplifier Module



Product Features

- Available in RoHS compliant packaging
- 50 Ω RF impedance
- 130W Output P_{1dB}
- Single Supply Operation : Nominally 28V
- High Gain: 16 dB at 880 MHz
- High Efficiency: 42% at 880 MHz

Applications

- Base Station PA driver
- Repeater
- CDMA/GSM/EDGE

Symbol	Parameter		Units	Min.	Тур.	Max.	
Frequency	Frequency of Operation		MHz	869	-	894	
P _{1dB}	Output Power at 1dB Compression, 881 MHz		W	120	130	-	
Gain	Gain at 12W CDMA Output (Single Carrier IS-95)	, 881MHz	dB	14	16	-	
Gain Flatness	Peak-to-Peak Gain Variation, 869 - 894MHz, 12 V	Vatt	dB	-	0.5	1.0	
Efficiency	Drain Efficiency at 120 Watts Output Power, CW	880 MHz	%		42		
Efficiency	Drain Efficiency at 24 Watts Output Power, 869 -	894MHz	%		20		
IRL	Input Return Loss 24W CW Output Power, 869 -	894MHz	dB	-	-15	-12	
00111 1000	IS-95, 9 Ch Fwd, Offset=750KHz, 881MHz, Pout	=12W avg	dBc	-	-55	-50	
CDMA ACPR Integrated Bandwidth	IS-95, 9 Ch Fwd, Offset=1.98MHz, 881MHz, Pou	t=12W avg	dBc		-63	-60	
I mogratou zanaman	IS-95, 9 Ch Fwd, Offset=750kHz, 881MHz, Pout=	24W avg	dBc	-	-46	-	
IMD	3rd Order IMD Product,120W PEP, 880MHz and	881MHz	dBc	-	-34	-30	
Delay	Signal Delay from Pin 3 to Pin 8		nS	-	4.0	-	
Phase Linearity	Deviation from Linear Phase (Peak-to-Peak)		Deg	-	0.7	-	
R _{TH}	Thermal Resistance (Junction-to-Case)		°C/W		0.7		
Test Conditions $Z_{in} = Z_{out} = 50\Omega$, $V_{DD} = 28.0V$, $I_{DQ1} = I_{DQ2} = 600$ mA $T_{Flange} = 25$ °C							

Quality Specifications

Key Specifications

Parameter	Description	Unit	Typical
ESD Rating	Human Body Model	Volts	2000
MTTF	200°C Channel	Hours	1.2 X 10 ⁶

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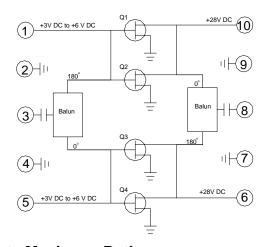
Propmfield CO 80021



Pin Description

Pin#	Function	Description
1	V_{GS1}	LDMOS FET Q1 and Q2 gate bias. V _{GSTH} 3.0 to 5.0 VDC. See Notes 2, 3 and 4
2,4,7,9	Ground	Module Topside ground.
3	RF Input	Internally DC blocked
5	V_{GS2}	LDMOS FET Q3 and Q4 gate bias. V _{GSTH} 3.0 to 5.0 VDC. See Notes 2, 3 and 4
6	V _{D2}	LDMOS FET Q3 and Q4 drain bias. See Note 1.
8	RF Output	Internally DC blocked
10	V _{D1}	LDMOS FET Q1 and Q2 drain bias. See Note 1.
Flange	Ground	Baseplate provides electrical ground and a thermal transfer path for the device. Proper mounting assures optimal performance and the highest reliability. See Sirenza applications note AN-054 Detailed Installation Instructions for Power Modules.

Simplified Device Schematic



Absolute Maximum Ratings

Parameters	Value	Unit
Drain Voltage (V _{DD})	35	V
RF Input Power	+43	dBm
Load Impedance for Continuous Operation Without Damage	5:1	VSWR
Control (Gate) Voltage, VDD = 0 VDC	15	V
Output Device Channel Temperature	+200	۰C
Operating Temperature Range	-20 to +90	°C
Storage Temperature Range	-40 to +100	°C

Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation see typical setup values specified in the table on page one.

Note 1:

Internal RF decoupling is included on all bias leads. No additional bypass elements are required, however some applications may require energy storage on the V_D leads to accommodate modulated signals.

Note 2:

Gate voltage must be applied to V_{GS} leads simultaneously with or after application of drain voltage to prevent potentially destructive oscillations. Bias voltages should never be applied to a module unless it is properly terminated on both input and output.

Note 3:

The required V $_{GS}$ corresponding to a specific I $_{DQ}$ will vary from module to module and may differ between V $_{GS1}$ and V $_{GS2}$ on the same module by as much as ± 0.10 volts due to the normal die-to-die variation in threshold voltage. LDMOS transistors.

Note 4

The threshold voltage (V_{GSTH}) of LDMOS transistors varies with device temperature. External temperature compensation may be required. See Sirenza application notes AN-067 LDMOS Bias Temperature Compensation.

Note 5:

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This module was designed to have it's leads hand soldered to an adjacent PCB. The maximum soldering iron tip temperature should not exceed 700° F, and the soldering iron tip should not be in direct contact with the lead for longer than 10 seconds. Refer to app note AN054 (www.sirenza.com) for further installation instructions.



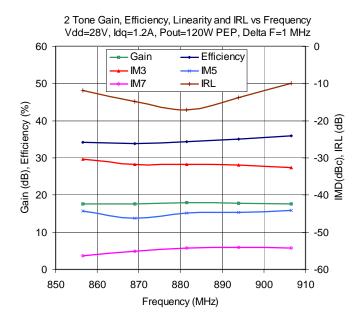
Caution: ESD Sensitive

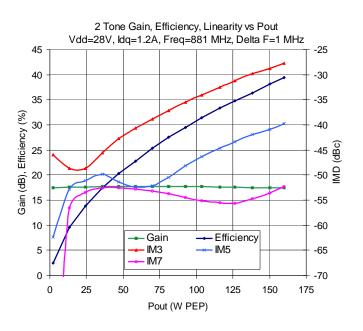
Appropriate precaution in handling, packaging and testing devices must be observed.

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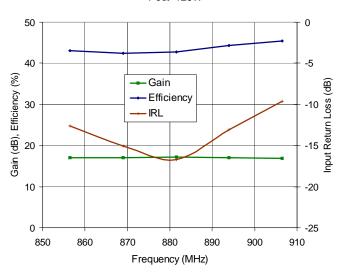


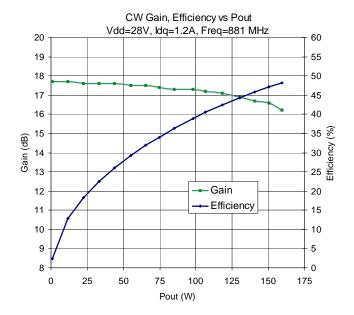
Typical Performance Curves





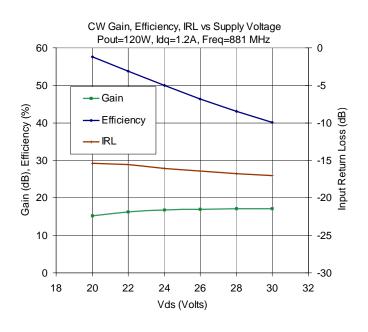


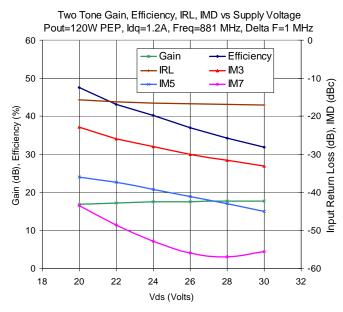


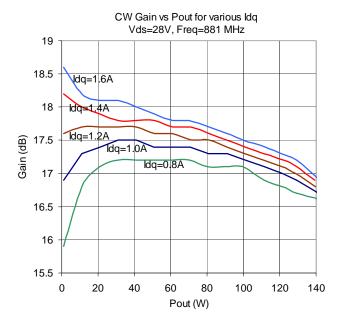


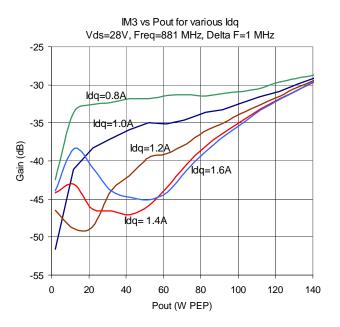


Typical Performance Curves (cont'd)









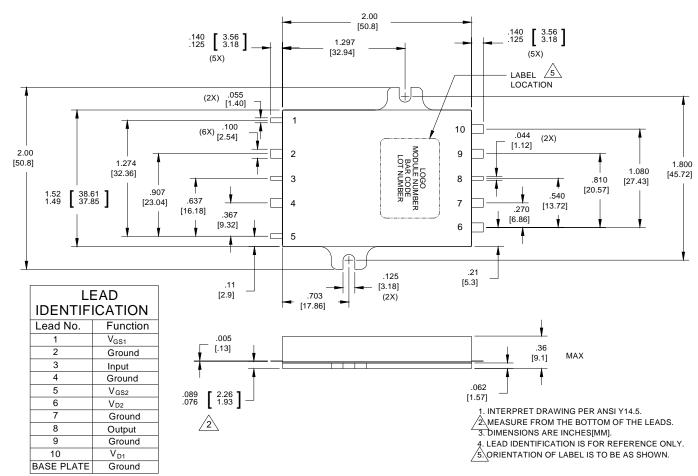
Note:

Evaluation test fixture information available on Sirenza Website, referred to as SDM-EVAL.

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Package Outline Drawing



MODULE WEIGHT = 41gm NOMINAL

Note

Refer to Application note AN054, "Detailed Installation Instructions for Power Modules" for detailed mounting information.

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